October 2007



FFP15S60S

Features

- High Speed Switching, t_{rr} < 35ns @ I_F = 15A
- High Reverse Voltage and High Reliability
- · RoHS compliant

Applications

- · General Purpose
- Switching Mode Power Supply
- · Boost Diode in continuous mode power factor corrections
- · Power switching circuits



STEALTHTM II Rectifier

15A, 600V STEALTH™ II Rectifier

The FFP15S60S is STEALTH TM II rectifier with soft recovery characteristics. It is silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as freewheeling of boost diode in switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.





2. Anode



1. Cathode 2. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{RRM}	Peak Repetitive Reverse Voltage	600	V
V _{RWM}	Working Peak Reverse Voltage	600	V
V _R	DC Blocking Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 123°C	15	А
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	150	А
T _J , T _{STG}	Operating and Storage Temperature Range	-65 to +150	°C

Thermal Characteristics

Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	1.3	°C/W

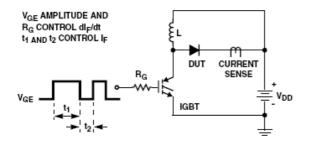
Package Marking and Ordering Information

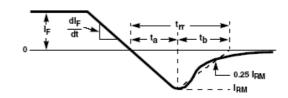
Device Marking Device		Package	Reel Size	Tape Width	Quantity	
	F15S60S	FFP15S60STU	TO-220-2L	-	=	50

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} 1	I _F = 15A I _F = 15A	$T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 125^{\rm o}{\rm C}$		2.1 1.6	2.6	V
I _{RM} 1	V _R = 600V V _R = 600V	$T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$			100 500	μА
t _{rr}	$I_F = 1A$, di/dt = 100A/ μ s, $V_R = 30V$	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	21	30	ns
t _{rr} I _{rr} S factor Q _{rr}	$I_F = 15A$, di/dt = 200A/ μ s, $V_R = 390V$	T _C = 25°C	- - -	23 2.5 0.7 29	35 - - -	ns A nC
t _{rr} I _{rr} S factor Q _{rr}	$I_F = 15A$, di/dt = 200A/ μ s, $V_R = 390V$	T _C = 125°C	- - -	55 4.3 1.1 118	- - -	ns A nC
W _{AVL}	Avalanche Energy (L = 40mH)		20	-	-	mJ

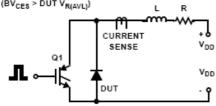
Test Circuit and Waveforms

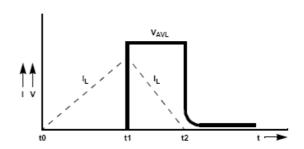




L = 40mH $R \le 0.1\Omega$ $V_{DD} = 50V$

 $\mathsf{EAVL} = 1/2\mathsf{L}\mathsf{I2} \; [\mathsf{V}_{\mathsf{R}(\mathsf{AVL})}/(\mathsf{V}_{\mathsf{R}(\mathsf{AVL})} - \mathsf{V}_{\mathsf{DD}})]$ Q1 = IGBT (BV_{CES} > DUT V_{R(AVL)})





Notes: 1: Pulse: Test Pulse width = 300μ s, Duty Cycle = 2%

Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop vs. Forward Current

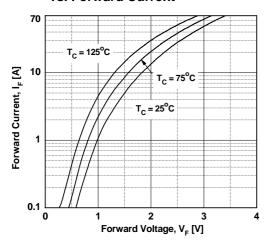


Figure 3. Typical Junction Capacitance

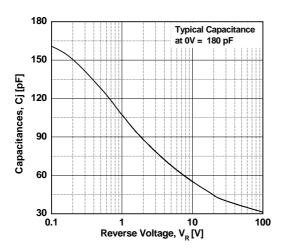


Figure 5. Typical Reverse Recovery Current vs. di/dt

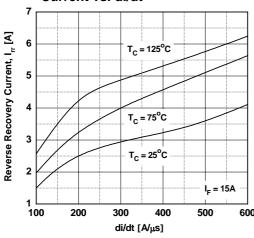


Figure 2. Typical Reverse Current vs. Reverse Voltage

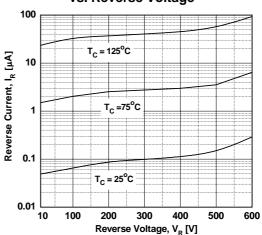


Figure 4. Typical Reverse Recovery Time vs. di/dt

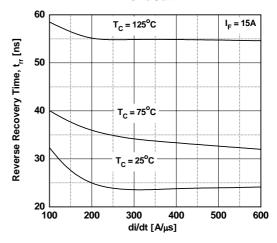
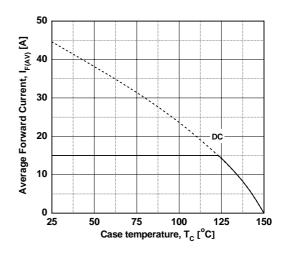


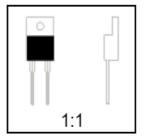
Figure 6. Forward Current Derating Curve



Mechanical Dimensions

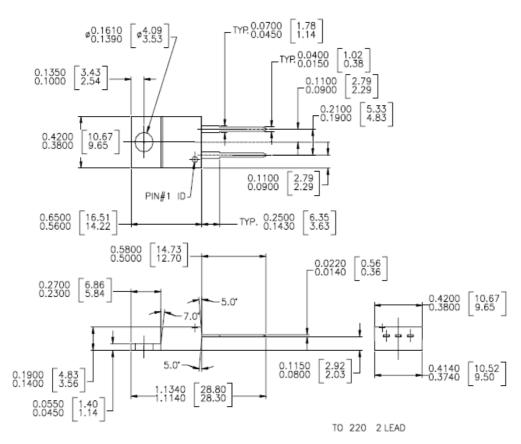
TO-220-2L





Scale 1:1 on letter size paper Dimensions shown below are in: inches [millimeters]

Part Weight per unit (gram): 2.24



NOTE: UNLESS OTHERWISE SPECIFIED

1. STANDARD LEAD FINISH : 200 MICROINCHES / 5.08 MICRON MINIMUM LEAD / TIN 15/85 ON OLIN 194 COPPER OR EQUIVALENT

2. DIMENSION BASED ON JEDEC STANDARD TO-220 VARIATION AB, ISSUE J, DATED 3/24/87

Dimensions in Millimeters



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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition		
		This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed Full Production		This datasheet contains final specifications. Fairchild Semiconductor reserv the right to make changes at any time without notice to improve design.		
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.		

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